

Title (en)

A method for profiling laths for parquet and squaring machine suited to realize such a method

Title (de)

Verfahren zur Profilierung von Holzleisten für Parkett und Ausrichtungsmaschine zur Verwendung in solch einem Verfahren

Title (fr)

Procédé pour profiler de moulures pour parquet et dispositif d'équarrissage pour un tel procédé

Publication

EP 1048423 B1 20030924 (EN)

Application

EP 00108072 A 20000425

Priority

IT VI990081 A 19990429

Abstract (en)

[origin: EP1048423A2] A method (L) for profiling laths for parquet aligned on a tow chain (9) enclosed in the case (19) of the base (2) of a squaring machine (1) provided with a plurality of operating heads (3, 4, 5, 6, 7). The method comprises the following operations: engravings the face (L') of each lath (L) towards said chain (9) a couple of longitudinal engravings (S', S''); millings on both lateral ribs (B', B'') of each lath (L); shaping the lateral ribs (B', B'') for the whole length making on one of said ribs (B') a male profile (M) and on the opposite rib (B'') a female profile (F). The distance (D) between said engravings (S', S'') is lower than the width (24) of said case (19), each of said engravings being obtained by a rotating tool (3'; 3''; 4'; 4'') belonging to one of said operating heads (3a, 3b, 4a, 4b) and having the rotating plane (30', 30'', 40', 40'') sloping in respect with the faces of the lath (L). <IMAGE>

IPC 1-7

B27M 1/08; **B27F 1/06**; **B27M 3/04**; **E04F 15/10**

IPC 8 full level

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CPC (source: EP)

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Cited by

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